

Complementary (N- and P-Channel) MOSFET

PRODUCT SUMMARY

	V _{DS} (V)	R _{DS(on)} (Ω)	I _D (A) ^a	Q _g (Typ.)
N-Channel	30	0.017 at V _{GS} = 10 V	12	7.9
		0.020 at V _{GS} = 4.5 V	11	
P-Channel	- 8	0.027 at V _{GS} = - 4.5 V	- 8	16.5
		0.037 at V _{GS} = - 2.5 V	- 6.8	

FEATURES

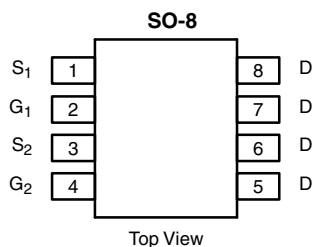
- Halogen-free According to IEC 61249-2-21 Definition
- TrenchFET® Power MOSFET
- 100 % R_g and UIS Tested
- Compliant to RoHS Directive 2002/95/EC



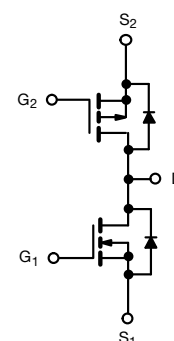
RoHS
COMPLIANT
HALOGEN
FREE

APPLICATIONS

- Level Shift
- Load Switch



Ordering Information: Si4501BDY-T1-GE3 (Lead (Pb)-free and Halogen-free)



ABSOLUTE MAXIMUM RATINGS (T_A = 25 °C, unless otherwise noted)

Parameter	Symbol	N-Channel	P-Channel	Unit
Drain-Source Voltage	V _{DS}	30	- 8	V
Gate-Source Voltage	V _{GS}	± 20	± 8	
Continuous Drain Current (T _J = 150 °C)	I _D	T _C = 25 °C	12	A
		T _C = 70 °C	9.5	
		T _A = 25 °C	g ^{b, c}	
		T _A = 70 °C	7.2 ^{b, c}	
Pulsed Drain Current (10 μs Pulse Width)	I _{DM}	40	- 40	A
Source-Drain Current Diode Current	I _S	T _C = 25 °C	4.0	
		T _A = 25 °C	2.2 ^{b, c}	
Pulsed Source-Drain Current	I _{SM}	40	- 40	
Single Pulse Avalanche Current	I _{AS}	5	- 5	mJ
Single Pulse Avalanche Energy	E _{AS}	1.25	1.25	
Maximum Power Dissipation	P _D	T _C = 25 °C	4.5	
		T _C = 70 °C	2.8	
		T _A = 25 °C	2.5 ^{b, c}	
		T _A = 70 °C	1.6 ^{b, c}	
Operating Junction and Storage Temperature Range	T _J , T _{stg}	- 55 to 150		°C

THERMAL RESISTANCE RATINGS

Parameter	Symbol	N-Channel		P-Channel		Unit
		Typ.	Max.	Typ.	Max.	
Maximum Junction-to-Ambient ^{b, d}	R _{thJA}	40	50	52	62.5	°C/W
Maximum Junction-to-Foot (Drain)	R _{thJF}	22	28	32	40	

Notes:

a. Based on T_C = 25 °C.

b. Surface mounted on 1" x 1" FR4 board.

c. t = 10 s.

d. Maximum under steady state conditions is 95 °C/W (N-Channel) and 110 °C/W (P-Channel).

SPECIFICATIONS ($T_J = 25\text{ }^{\circ}\text{C}$, unless otherwise noted)

Parameter	Symbol	Test Conditions		Min.	Typ. ^a	Max.	Unit
Static							
Drain-Source Breakdown Voltage	V _{DS}	V _{GS} = 0 V, I _D = 250 μA	N-Ch	30			V
		V _{GS} = 0 V, I _D = - 250 μA	P-Ch	- 8			
V _{DS} Temperature Coefficient	ΔV _{DS} /T _J	I _D = 250 μA	N-Ch		34		mV/°C
		I _D = - 250 μA	P-Ch		- 3		
V _{GS(th)} Temperature Coefficient	ΔV _{GS(th)} /T _J	I _D = 250 μA	N-Ch		- 4.5		
		I _D = - 250 μA	P-Ch		2.6		
Gate Threshold Voltage	V _{GS(th)}	V _{DS} = V _{GS} , I _D = 250 μA	N-Ch	0.8		2	V
		V _{DS} = V _{GS} , I _D = - 250 μA	P-Ch	- 0.45		- 0.9	
Gate-Body Leakage	I _{GSS}	V _{DS} = 0 V, V _{GS} = ± 20 V	N-Ch			± 100	nA
		V _{DS} = 0 V, V _{GS} = ± 8 V	P-Ch			± 100	
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 30 V, V _{GS} = 0 V	N-Ch			1	μA
		V _{DS} = - 8 V, V _{GS} = 0 V	P-Ch			- 1	
		V _{DS} = 30 V, V _{GS} = 0 V, T _J = 55 °C	N-Ch			5	
		V _{DS} = - 8 V, V _{GS} = 0 V, T _J = 55 °C	P-Ch			- 5	
On-State Drain Current ^b	I _{D(on)}	V _{DS} = 5 V, V _{GS} = 10 V	N-Ch	20			A
		V _{DS} = - 5 V, V _{GS} = - 4.5 V	P-Ch	- 20			
Drain-Source On-State Resistance ^b	R _{DS(on)}	V _{GS} = 10 V, I _D = 10 A	N-Ch		0.0135	0.017	Ω
		V _{GS} = - 4.5 V, I _D = - 6 A	P-Ch		0.021	0.027	
		V _{GS} = 4.5 V, I _D = 7 A	N-Ch		0.016	0.020	
		V _{GS} = - 2.5 V, I _D = - 5 A	P-Ch		0.029	0.037	
Forward Transconductance ^b	g _{fs}	V _{DS} = 15 V, I _D = 10 A	N-Ch		29		S
		V _{DS} = - 15 V, I _D = - 6 A	P-Ch		24		
Dynamic ^a							
Input Capacitance	C _{iss}	N-Channel V _{DS} = 15 V, V _{GS} = 0 V, f = 1 MHz P-Channel V _{DS} = - 4 V, V _{GS} = 0 V, f = 1 MHz	N-Ch		805		pF
			P-Ch		1400		
Output Capacitance	C _{oss}		N-Ch		170		
			P-Ch		660		
Reverse Transfer Capacitance	C _{rss}	N-Ch		80			
		P-Ch		630			
Total Gate Charge	Q _g	V _{DS} = 15 V, V _{GS} = 10 V, I _D = 10 A	N-Ch		16.5	25	nC
		V _{DS} = - 4 V, V _{GS} = - 8 V, I _D = - 6 A	P-Ch		27.5	42	
		N-Channel V _{DS} = 15 V, V _{GS} = 4.5 V, I _D = 10 A	N-Ch		7.9	12	
			P-Ch		16.5	25	
Gate-Source Charge	Q _{gs}	N-Ch		2.2			
		P-Ch		2.2			
Gate-Drain Charge	Q _{gd}	N-Ch		2.7			
		P-Ch		4.8			
Gate Resistance	R _g	f = 1 MHz	N-Ch	0.3	1.1	2.2	Ω
			P-Ch	0.9	4.2	8.4	



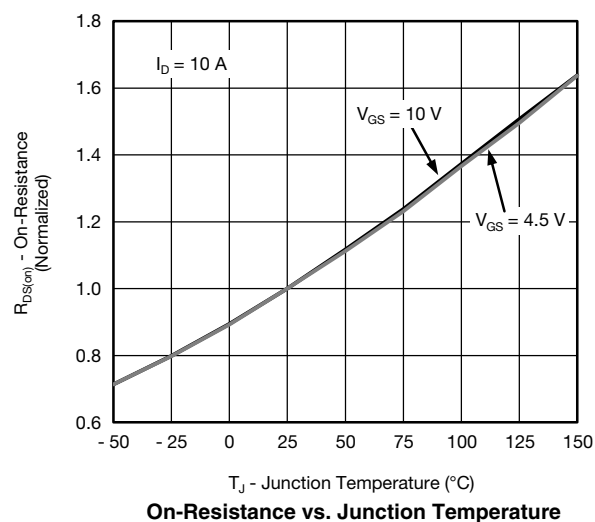
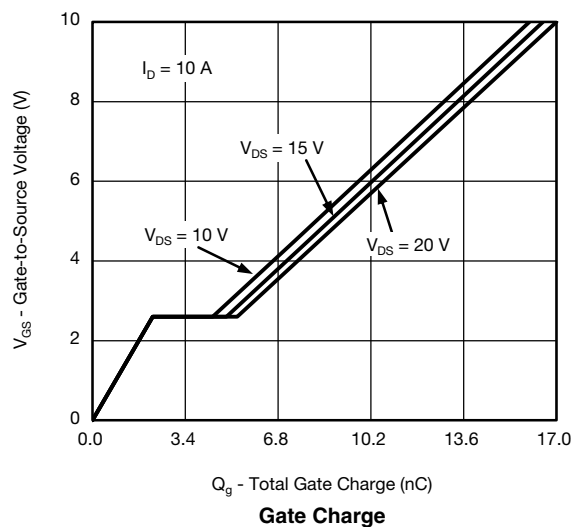
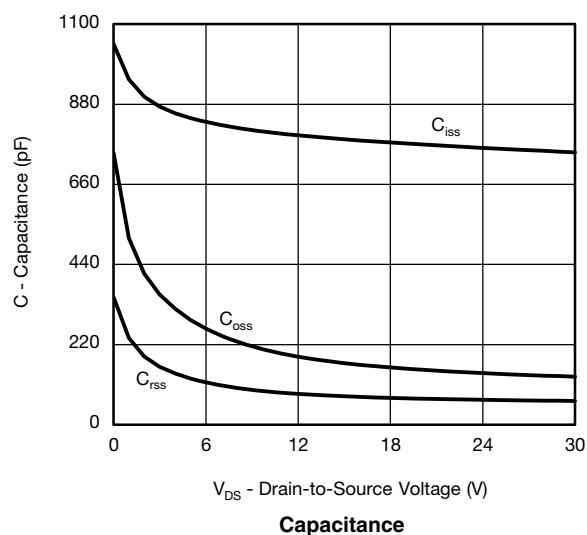
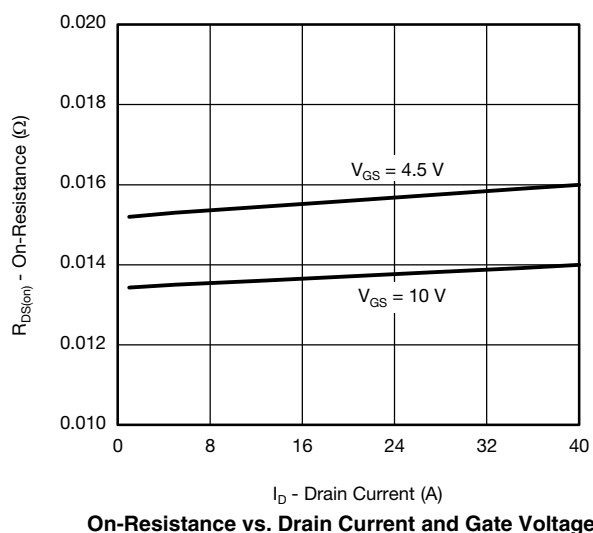
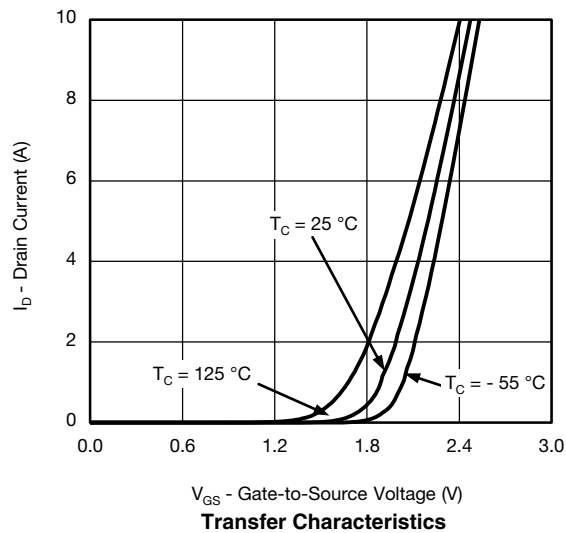
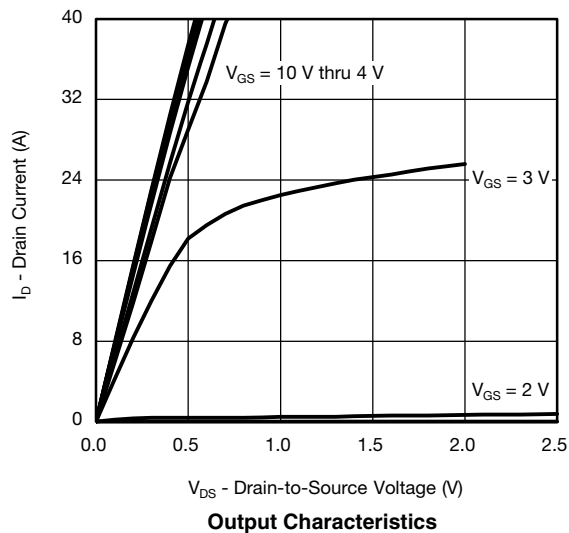
SPECIFICATIONS (T _J = 25 °C, unless otherwise noted)								
Parameter	Symbol	Test Conditions		Min.	Typ. ^a	Max.	Unit	
Dynamic ^a								
Turn-On Delay Time	t _{d(on)}	N-Channel V _{DD} = 15 V, R _L = 3 Ω I _D ≅ 5 A, V _{GEN} = 10 V, R _g = 1 Ω	N-Ch		7	14	ns	
			P-Ch		6	12		
Rise Time	t _r		N-Ch		11	22		
			P-Ch		12	24		
Turn-Off Delay Time	t _{d(off)}	P-Channel V _{DD} = - 4 V, R _L = 0.8 Ω I _D ≅ - 5 A, V _{GEN} = - 10 V, R _g = 1 Ω	N-Ch		15	30		
			P-Ch		35	65		
Fall Time	t _f		N-Ch		8	16		
			P-Ch		9	18		
Turn-On Delay Time	t _{d(on)}	N-Channel V _{DD} = 15 V, R _L = 3 Ω I _D ≅ 5 A, V _{GEN} = 4.5 V, R _g = 1 Ω	N-Ch		16	30		
			P-Ch		22	40		
Rise Time	t _r		N-Ch		55	100		
			P-Ch		18	35		
Turn-Off Delay Time	t _{d(off)}	P-Channel V _{DD} = - 4 V, R _L = 0.8 Ω I _D ≅ - 5 A, V _{GEN} = - 4.5 V, R _g = 1 Ω	N-Ch		22	40		
			P-Ch		34	65		
Fall Time	t _f		N-Ch		10	20		
			P-Ch		14	28		
Drain-Source Body Diode Characteristics								
Continuous Source-Drain Diode Current	I _S	T _C = 25 °C	N-Ch			4	A	
			P-Ch			- 2.8		
Pulse Diode Forward Current ^a	I _{SM}		N-Ch			40		
			P-Ch			- 40		
Body Diode Voltage	V _{SD}	I _S = 2 A	N-Ch		0.72	1.1	V	
		I _S = - 2 A	P-Ch		- 0.71	- 1.1		
Body Diode Reverse Recovery Time	t _{rr}	N-Channel I _F = 1.8 A, di/dt = 100 A/μs, T _J = 25 °C	N-Ch		14	28	ns	
			P-Ch		49	98		
Body Diode Reverse Recovery Charge	Q _{rr}		P-Channel I _F = - 1.8 A, di/dt = - 100 A/μs, T _J = 25 °C	N-Ch		5.5	11	nC
				P-Ch		47	94	
Reverse Recovery Fall Time	t _a			N-Ch		7.5		ns
				P-Ch		26		
Reverse Recovery Rise Time	t _b			N-Ch		6.5		
				P-Ch		23		

Notes:

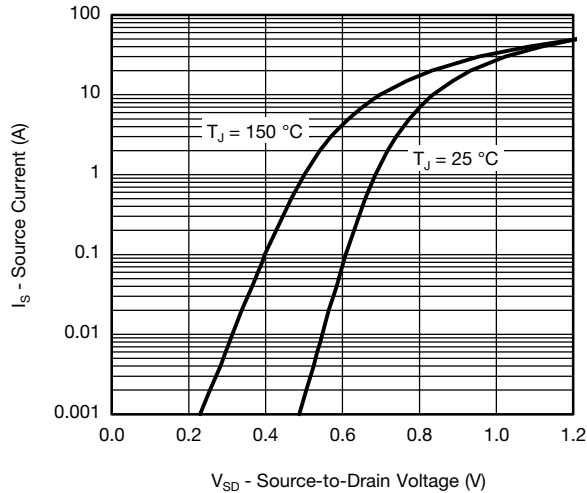
a. Guaranteed by design, not subject to production testing.

b. Pulse test; pulse width $\leq 300\text{ }\mu\text{s}$, duty cycle $\leq 2\%$.

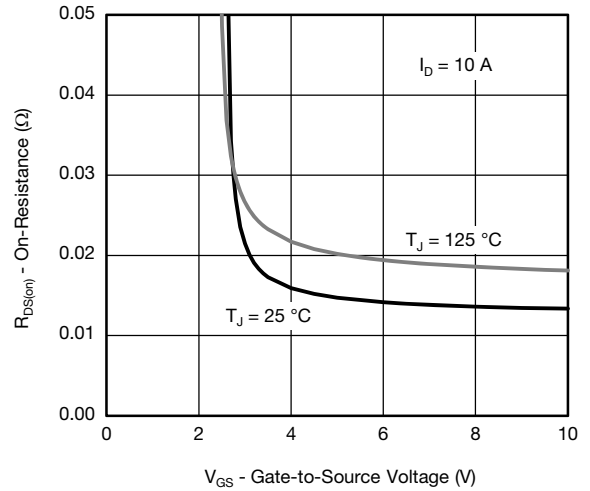
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

N-CHANNEL TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

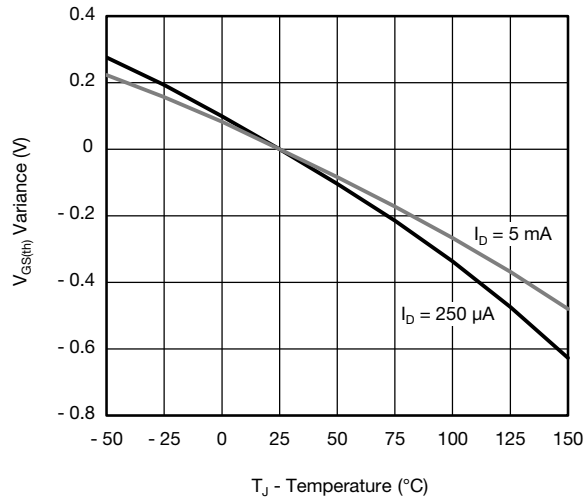
N-CHANNEL TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



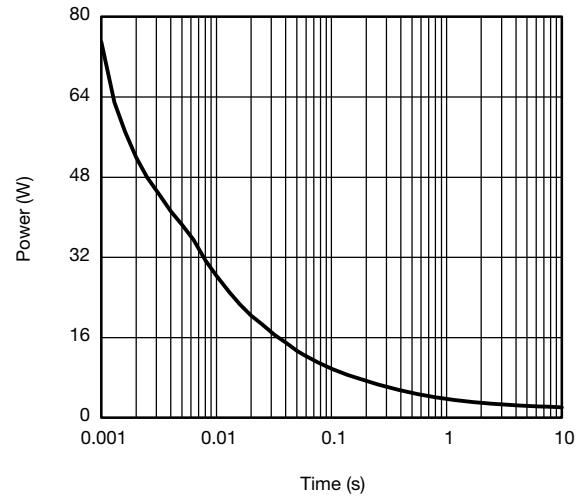
Source-Drain Diode Forward Voltage



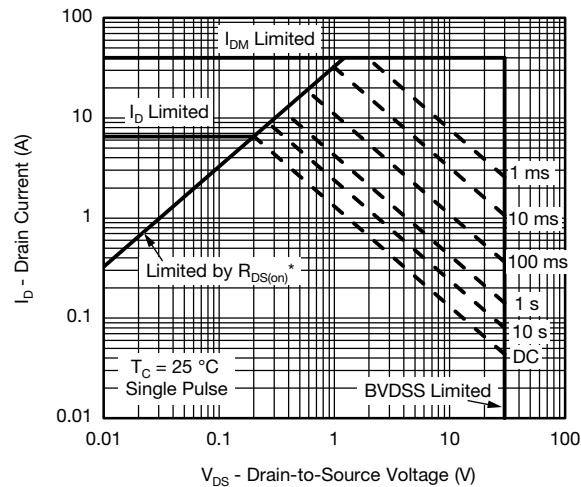
On-Resistance vs. Gate-to-Source Voltage



Threshold Voltage



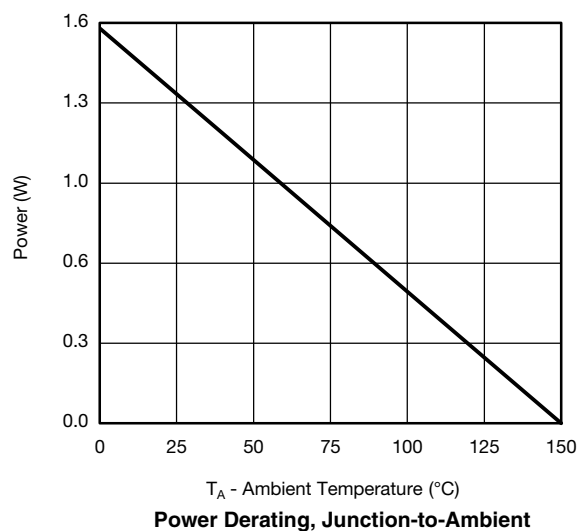
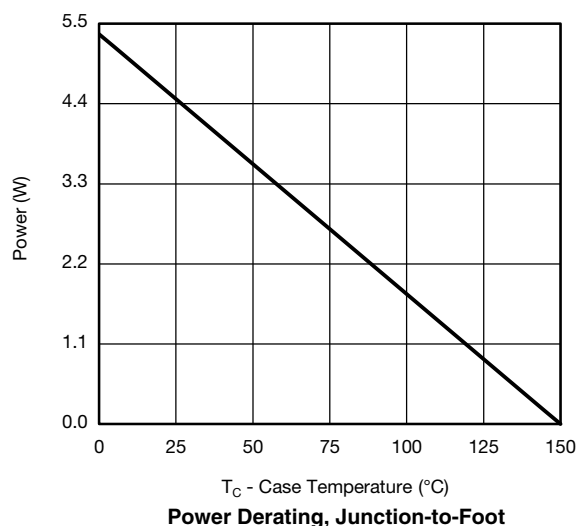
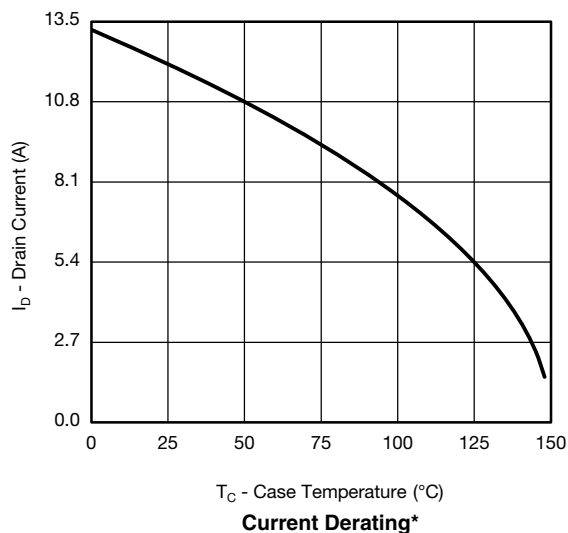
Single Pulse Power, Junction-to-Ambient



* $V_{GS} >$ minimum V_{GS} at which $R_{DS(on)}$ is specified

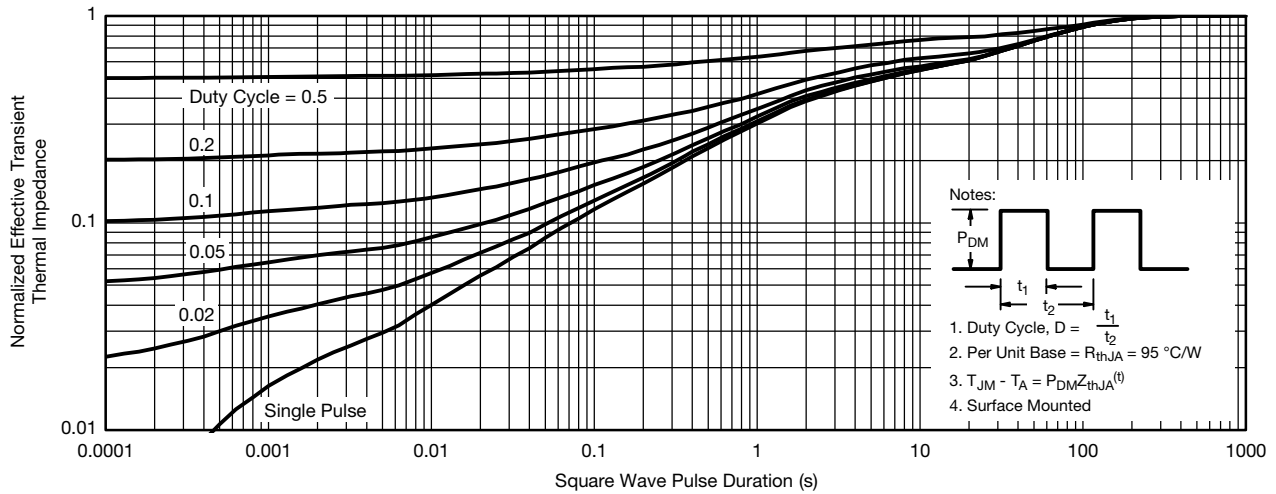
Safe Operating Area, Junction-to-Ambient

N-CHANNEL TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

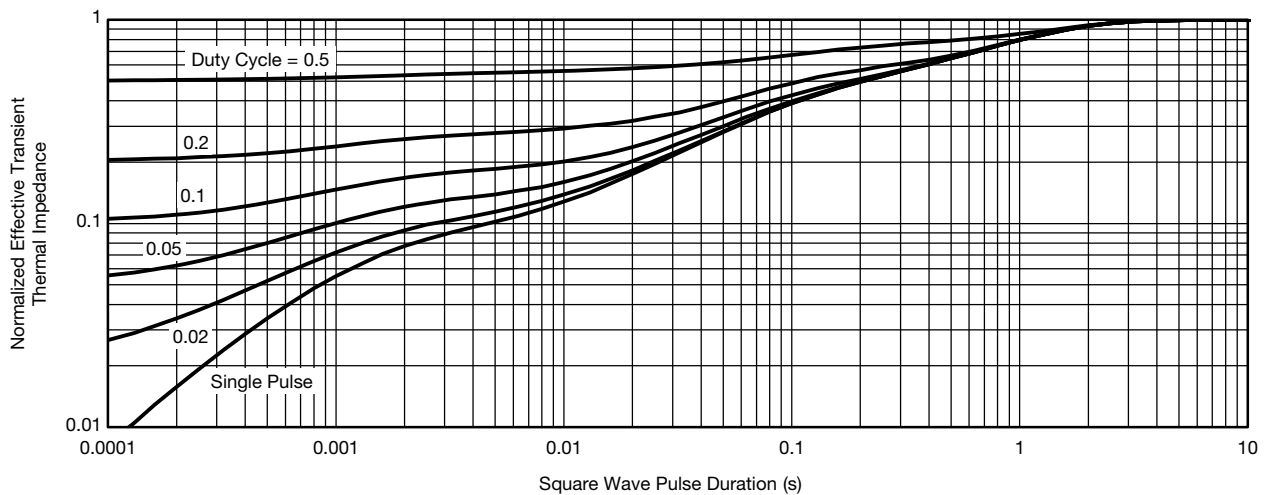


* The power dissipation P_D is based on $T_{J(max)} = 150$ °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

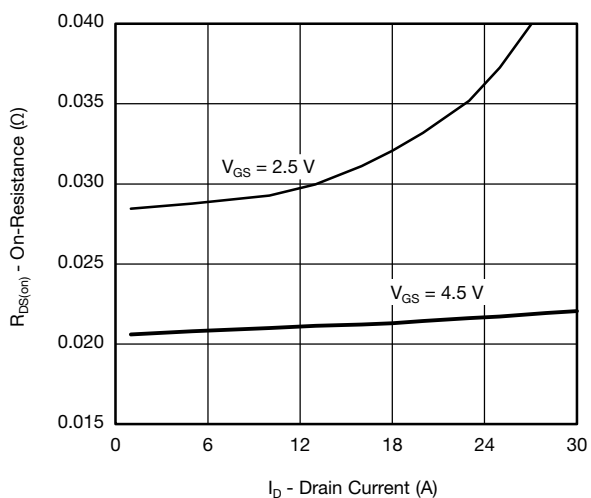
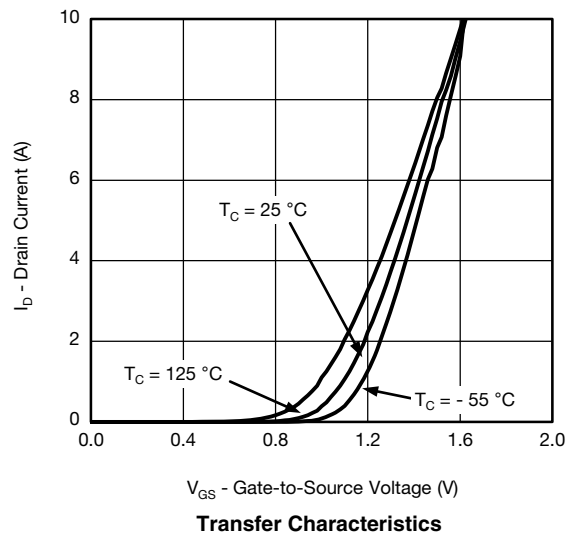
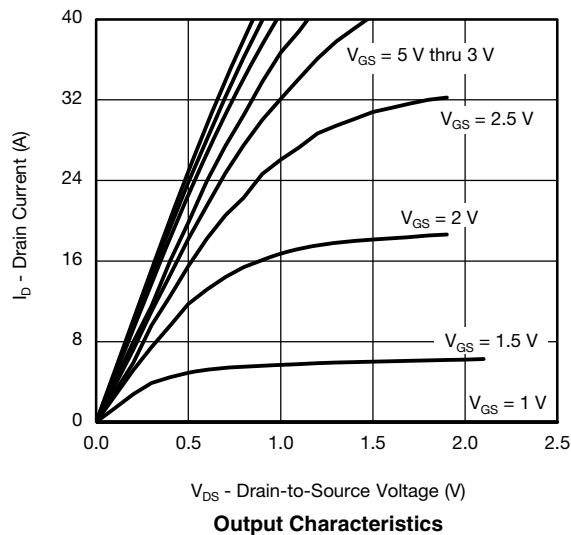
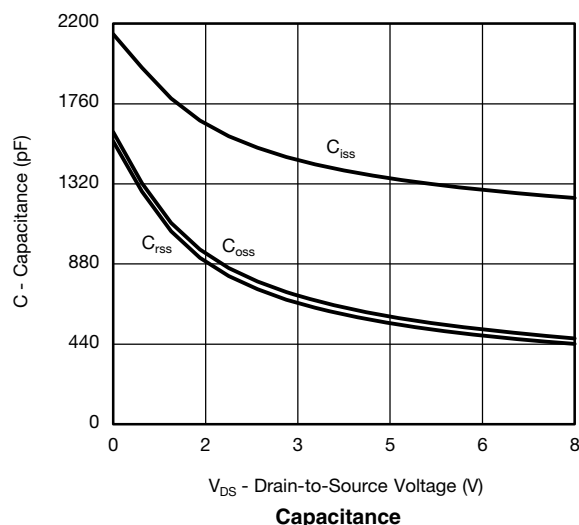
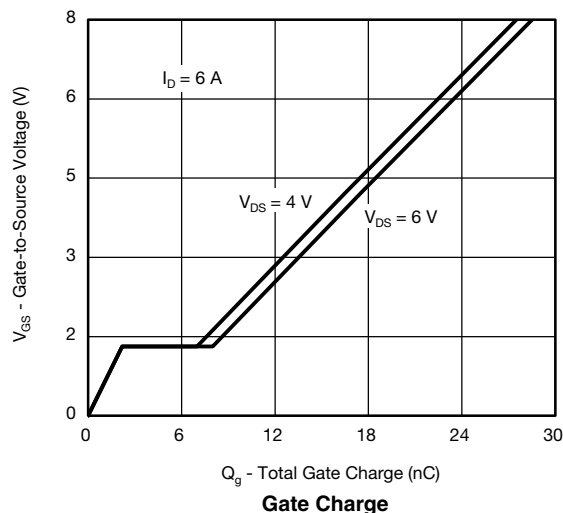
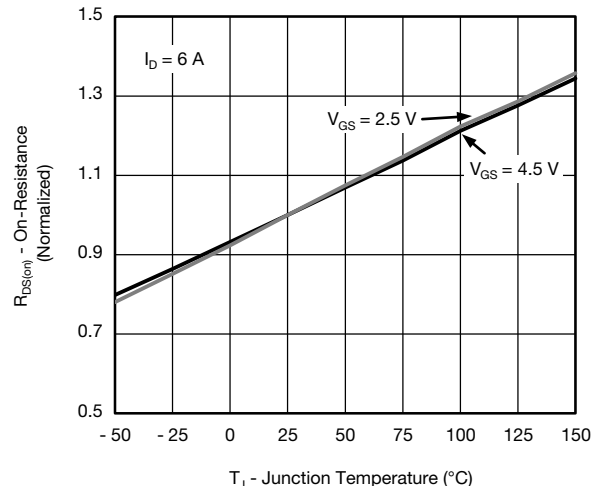
N-CHANNEL TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



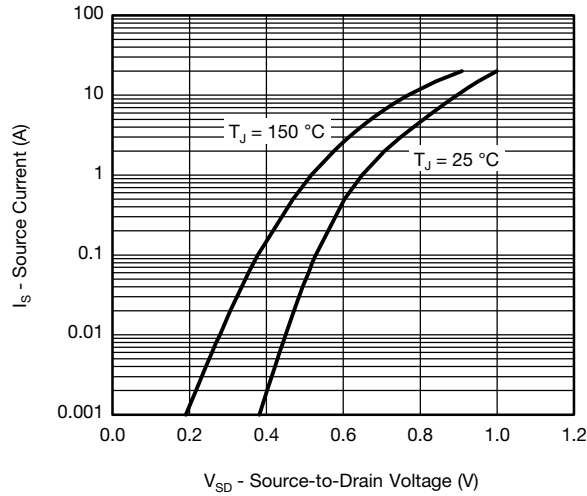
Normalized Thermal Transient Impedance, Junction-to-Ambient



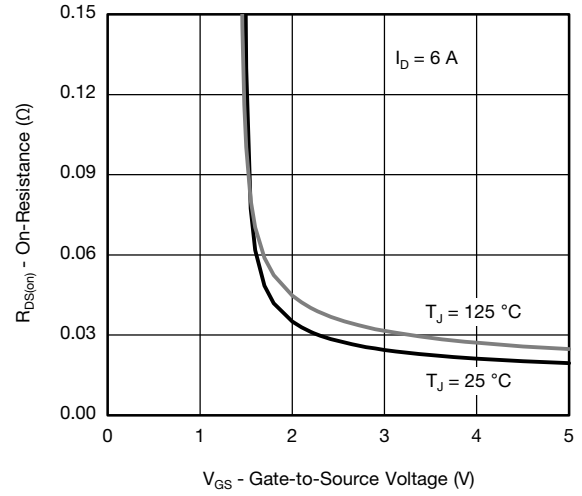
Normalized Thermal Transient Impedance, Junction-to-Foot

P-CHANNEL TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)**On-Resistance vs. Drain Current and Gate Voltage****Capacitance****Gate Charge****On-Resistance vs. Junction Temperature**

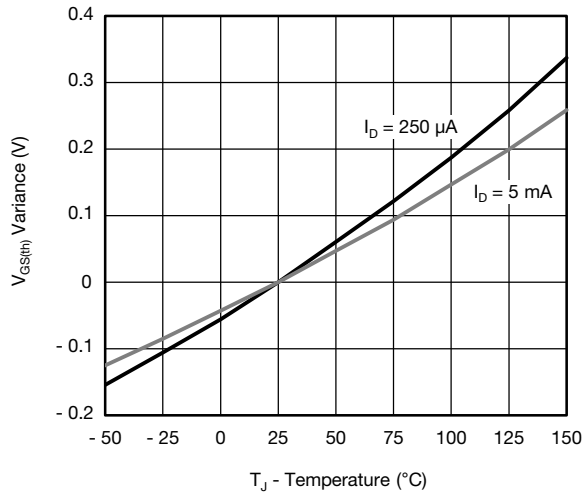
P-CHANNEL TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



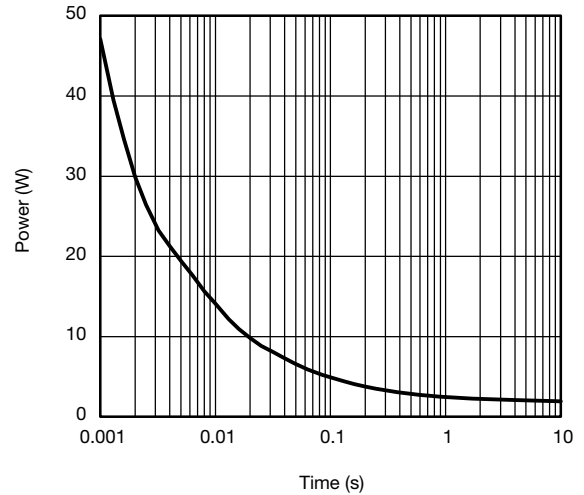
Source-Drain Diode Forward Voltage



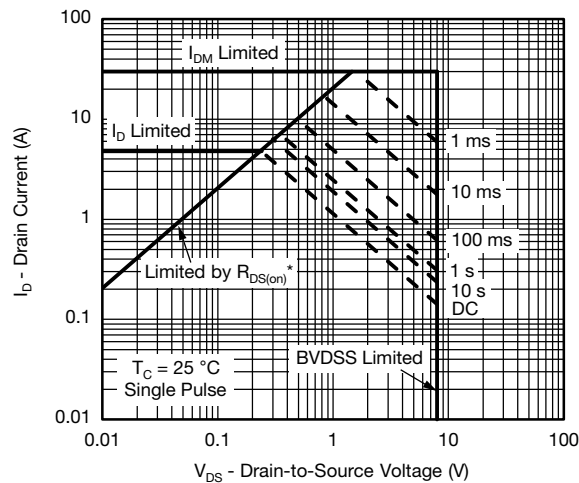
On-Resistance vs. Gate-to-Source Voltage



Threshold Voltage



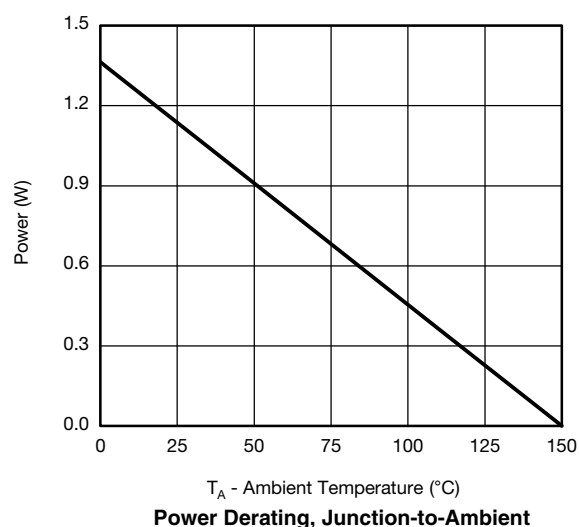
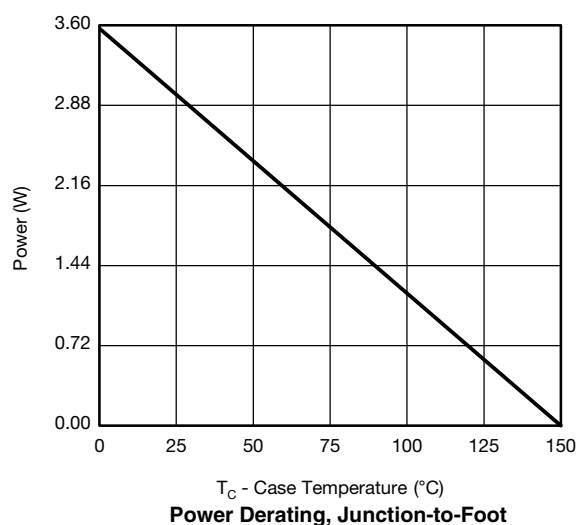
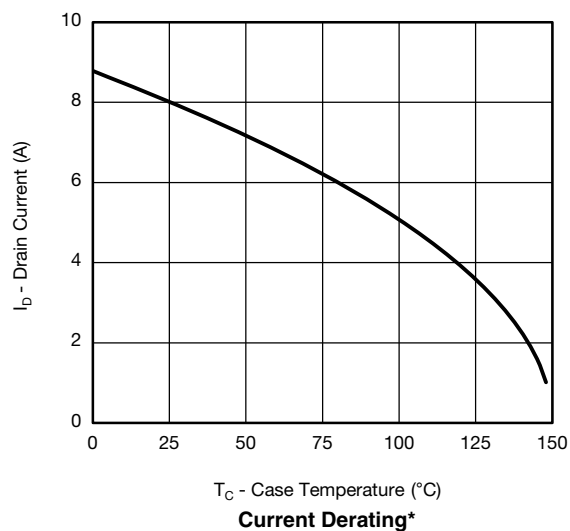
Single Pulse Power, Junction-to-Ambient



* $V_{GS} >$ minimum V_{GS} at which $R_{DS(on)}$ is specified

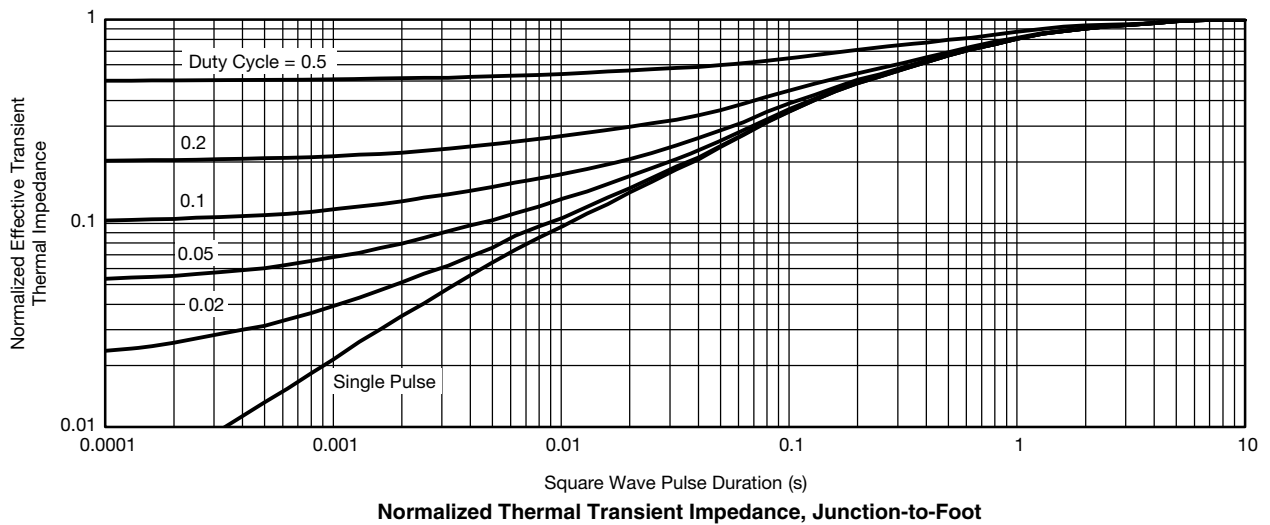
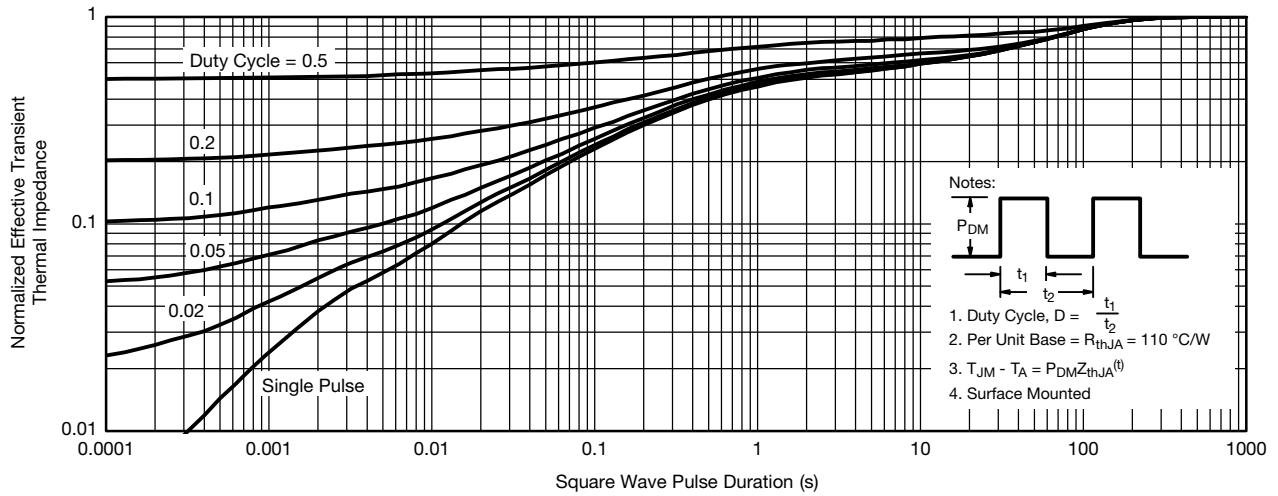
Safe Operating Area, Junction-to-Ambient

P-CHANNEL TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



* The power dissipation P_D is based on $T_{J(max)} = 150$ °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

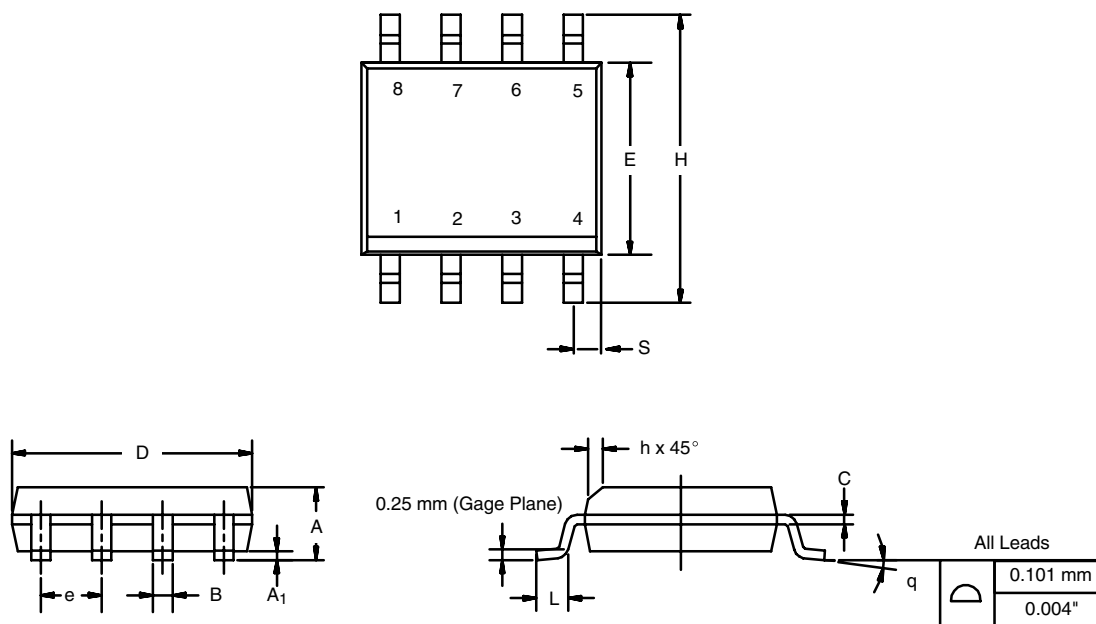
P-CHANNEL TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



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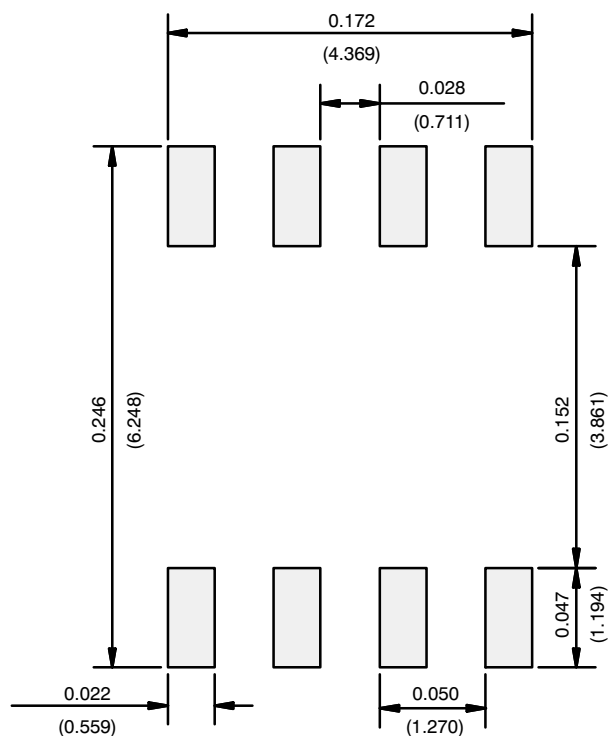
SOIC (NARROW): 8-LEAD

JEDEC Part Number: MS-012



DIM	MILLIMETERS		INCHES	
	Min	Max	Min	Max
A	1.35	1.75	0.053	0.069
A ₁	0.10	0.20	0.004	0.008
B	0.35	0.51	0.014	0.020
C	0.19	0.25	0.0075	0.010
D	4.80	5.00	0.189	0.196
E	3.80	4.00	0.150	0.157
e	1.27 BSC		0.050 BSC	
H	5.80	6.20	0.228	0.244
h	0.25	0.50	0.010	0.020
L	0.50	0.93	0.020	0.037
q	0°	8°	0°	8°
S	0.44	0.64	0.018	0.026
ECN: C-06527-Rev. I, 11-Sep-06				
DWG: 5498				

RECOMMENDED MINIMUM PADS FOR SO-8



Recommended Minimum Pads
Dimensions in Inches/(mm)

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